Ceatech



Driving innovation through technological research

10th Anniversary PSP Symposium Warsaw, Poland







Margaux TKATCHENKO Scientific Direction, CEA Tech

18 Mai 2018

A French key player in technological research



Alternative Energies and Atomic Energy Commission cea CEA Nuclear Defense Ceatech Technologies Security Energy Technological Nuclear Energy Military Research **Applications** Division Division Division 4500 4500 4500 pers. pers. pers. Science





Fundamental research Materials Sciences Division Life Sciences Division



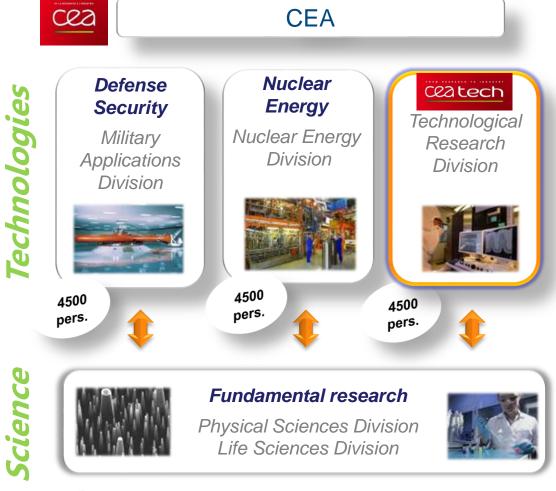
Mission DAM : strategic independence of France

Mission DEN : energy independence of France

Mission DRT : economic competitiveness of France

A french key player in technological research

Alternative Energies and Atomic Energy Commission



Mission DAM : strategic independence of France
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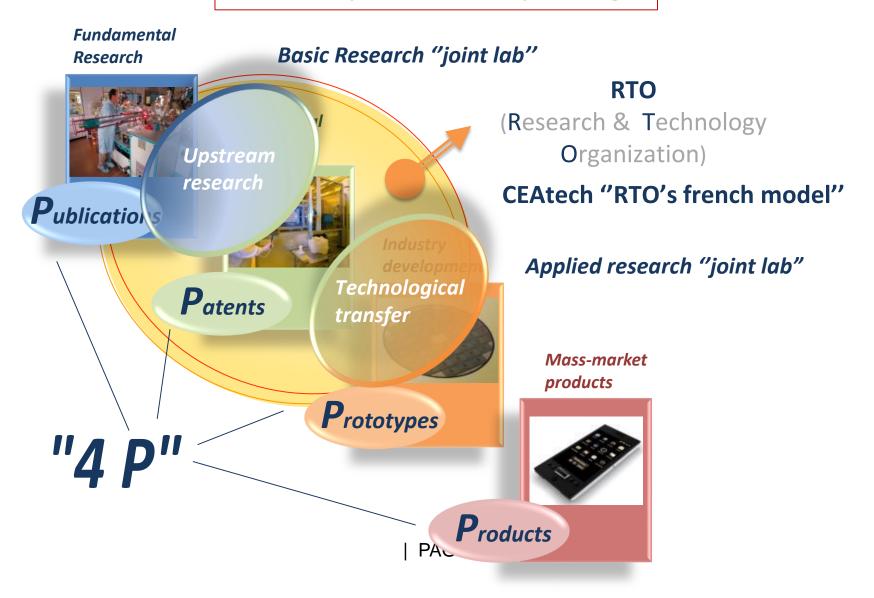


Payroll Staff : 16000 **10** Research centers Budget: **4,7 B€** 1000 PhD Publications: 4740 /year 4670 priority patent portfolio 700 priority patents per year **150** new companies established since 1984 in the high-tech industry **53** Joint research laboratories



A french key player in technological research

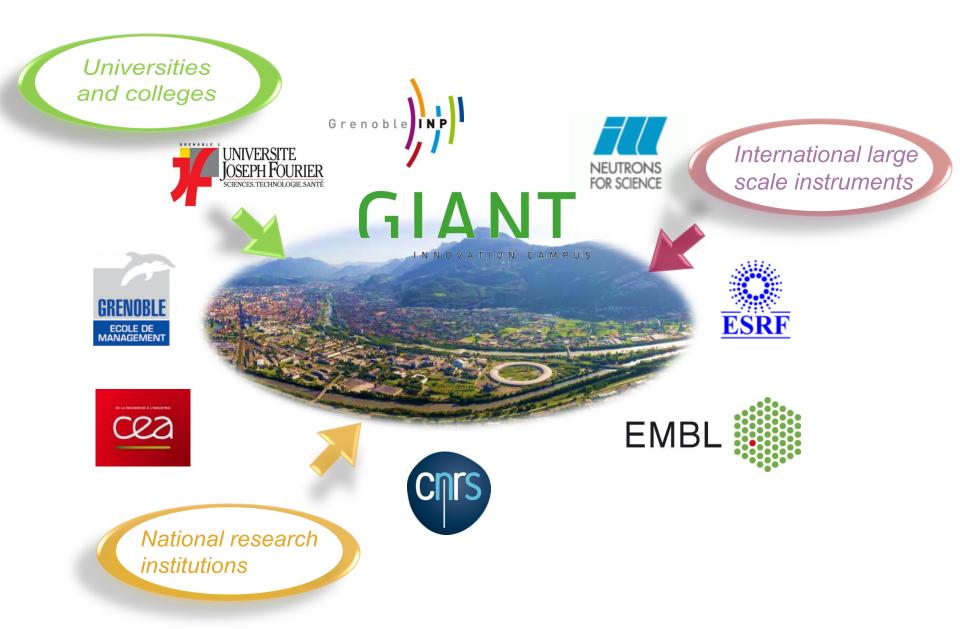
Innovation process : CEA-TECH positioning



At the heart of the Grenoble innovation ecosystem... ...from MINATEC to GIANT



CEA member of GIANT campus





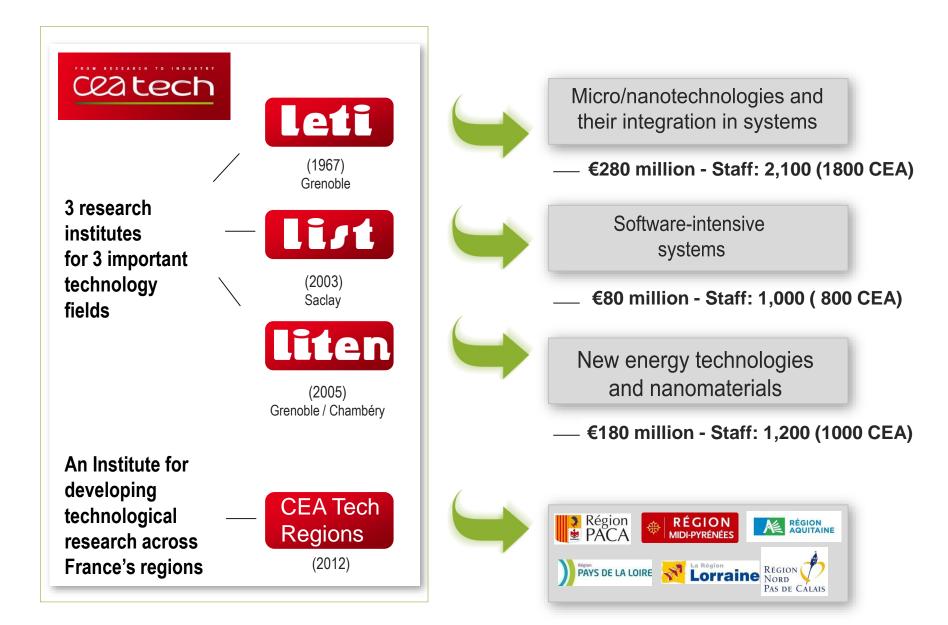


Model and Key Figures

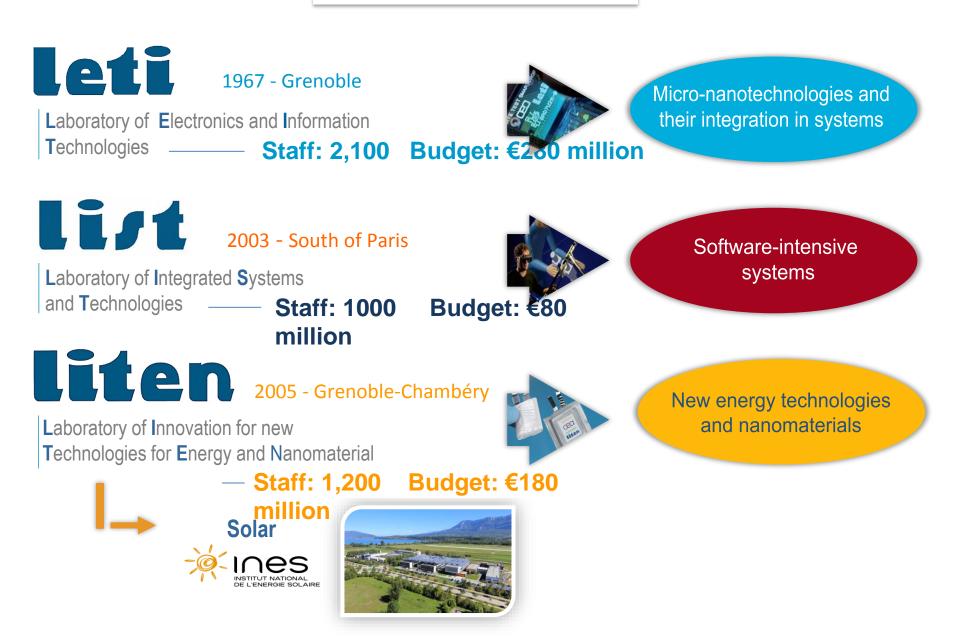
An unique model based on the ability to :

- Operate technology platforms
- Co-develop new products with industrial partners
- Protect the results of Research
- Ensure knowledge resourcing

The CEA-Tech model : our structure

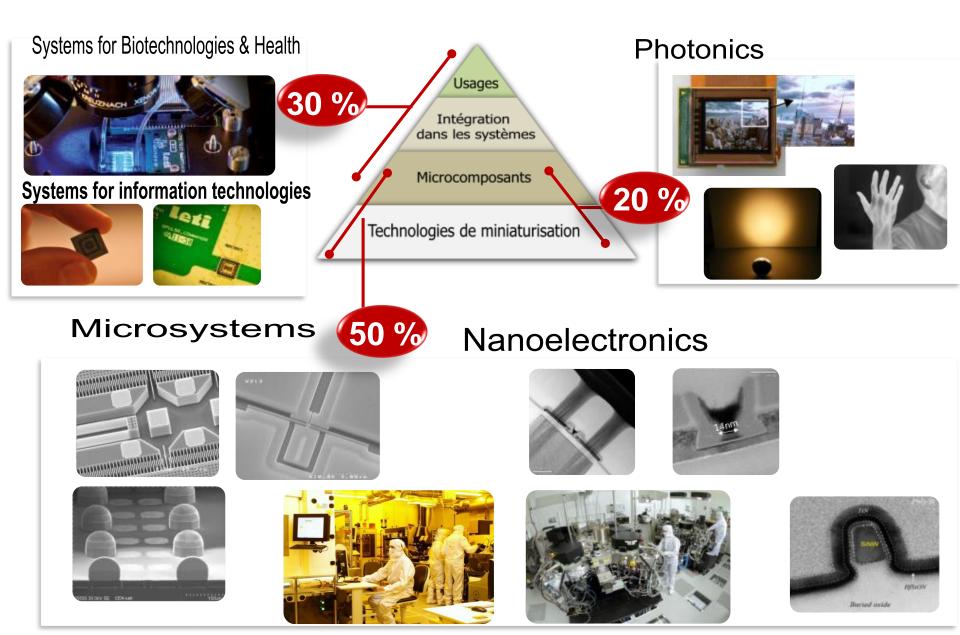


Key CEA Tech activities





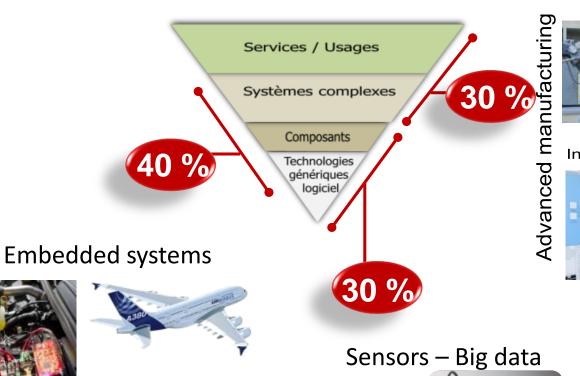








Nondestructive testing, virtual reality, robotics, cobotics





Interactive systems









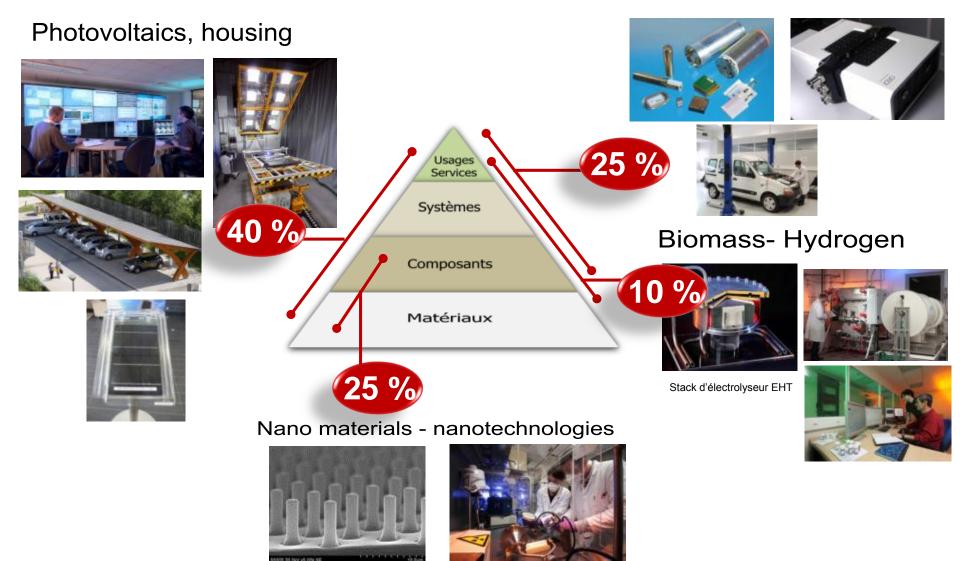


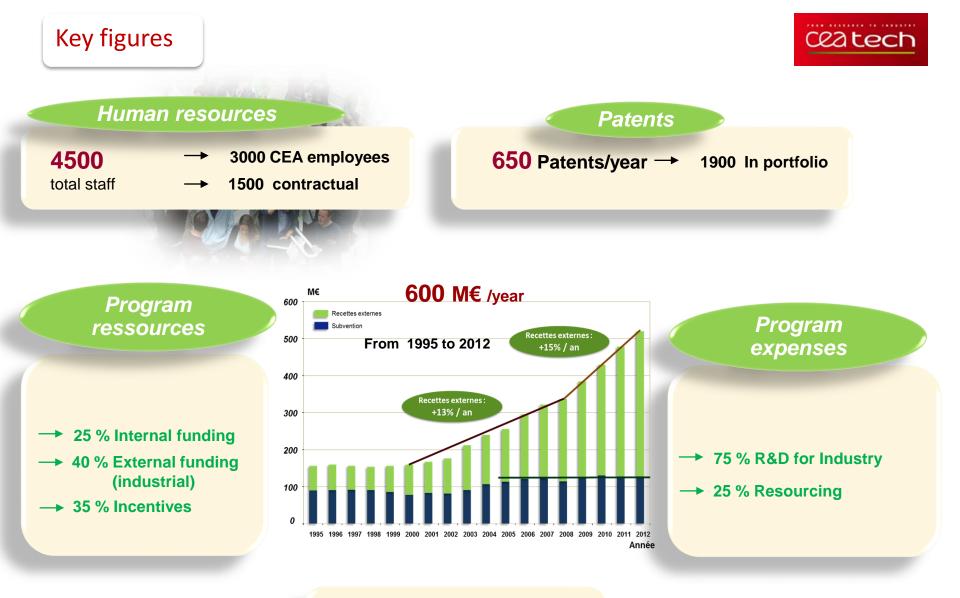


liten

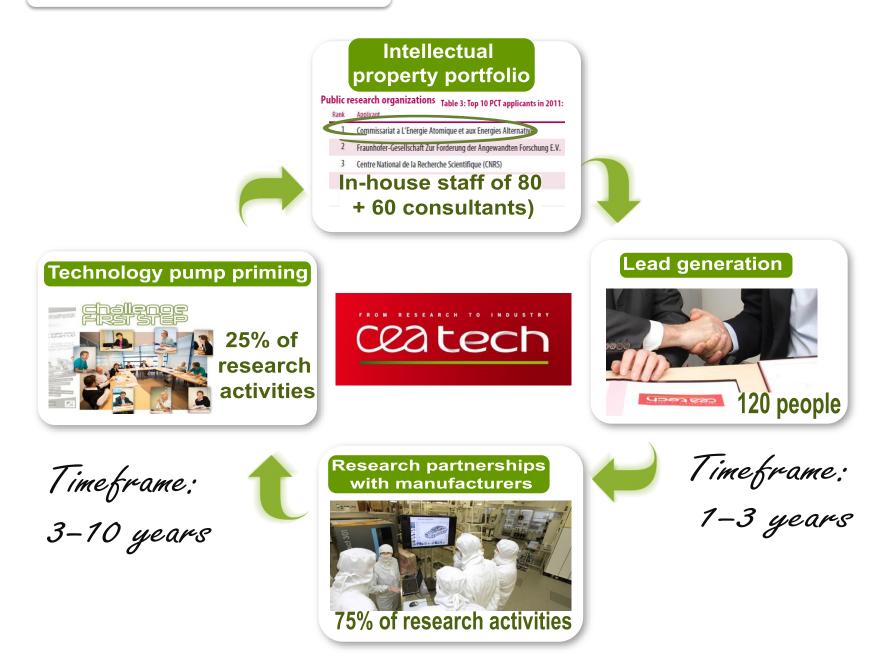


Carbon-free transportation





- → 47 % Staff costs
- → 33 % Operating costs
- → 20 % Investment



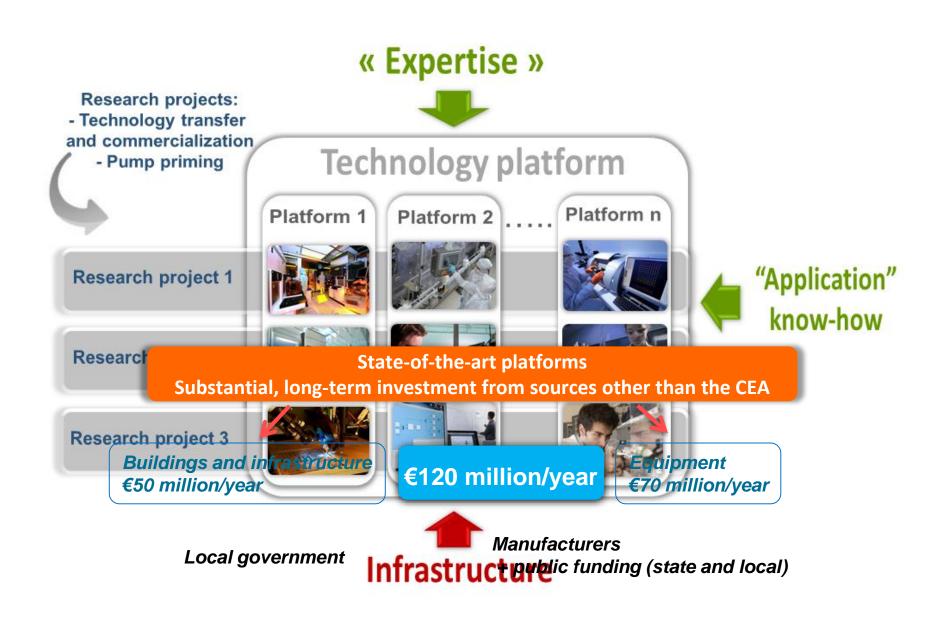




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✓ Example of microelectronic PLATFORMS







INSTITUT NANOSCIENCE ET CRYOGÉNIE

Grenoble INP

ΡΤΑ













✓ Leti NANOTECH 300 mm platform

300mm clean room







ceatech





200 mm clean room

✓ Leti MEMS 200 plaftorm













✓ MANUFACTURING

Non-destructive testing (NDT)

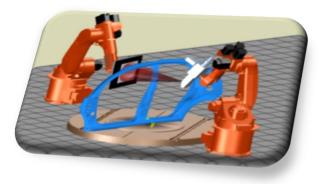


Robotics

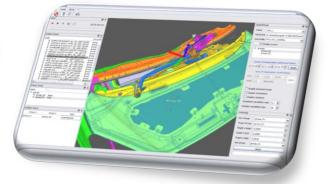


Virtual Reality









Embedded systems \checkmark



>

>

>

Safe command-control

Hardened camera

> Energy management

Ceatech

- IC & SOC simulation >
- > Imaging
- > EMC / RF Reliability
- > Smart Sensors

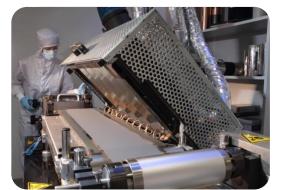




✓ The Liten batteries platform











✓ The Liten Energy platform





PLATEFORME TECHNOLO

Powder metallurgy platform \checkmark

Master powder formulation and preparation



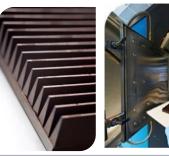






Injection/molding

Sintering furnaces



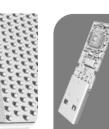


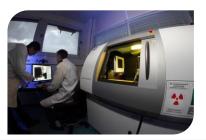




X-ray µ-tomography characterization







Material characterization







A 5,000 m2 building with 1,000 m2 of lab space, 7 training rooms, and 50 nanosafety experts and researchers

Nanosafety platform \checkmark



















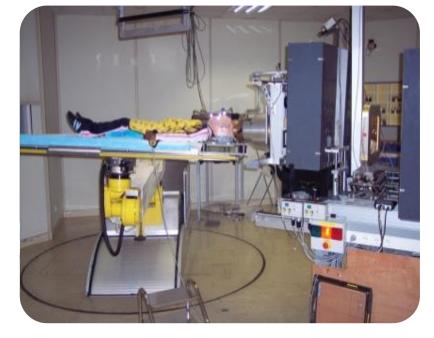
Prototype d'implant en cours de développement au Léti.



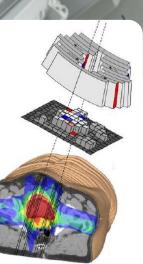


✓ DOSEO platform

development of technical solutions for radiotherapy technologies & imagery.









✓ The CEA Tech show room











✓ Design Platform

200 designers

35 patents / year

- Analog design
- Digital design
- Embedded software

Broad range of designed testing tools

- CAD tools from Cadence, Mentor Graphics,
 Synopsys, Agilent...
- Joint Lab with CAD vendors
- Automatic test equipement , RF prober..
- Access to advanced technology:

CMOS, 3D, photonics, MEMS, THz..and MPW





✓ Technology transfer and user-driven innovation platform

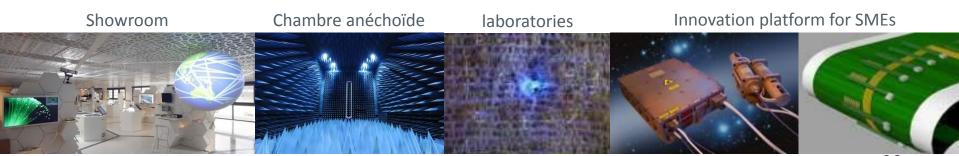
User-driven creativity sessions



Industries Integratives



An environment dedicated to innovation in SMEs





An unique model based on the ability to :

Operate technology platforms



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Co-developing new products with industrial partners



Competitiveness:

CEA Tech operations aligned with industrial standards

Staff	Experience in manufacturing and researchConstant acquisition of new skills			
Methods	 Compatibility with industrial standards Results-based culture Execution speed Clear reporting ISO 9001 certification based on customer satisfaction Technology transfer phase aligned with standards (TRL, FMECA) 			
Competitiveness on global markets	 Exposure to international customers (10% of industrial revenue) Constant benchmarking with other technological research organizations Contributions from leading innovation campuses (MINATEC, GIANT) 			



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CEA: Top patent filer among research centers worldwide

	Ranking	Applicant's name	Country	2012
_				
-	1	ZTE	China	3906
	2	Panasonic	Japan	2951
	3	Sharp	Japan	2001
	4	Huawei	China	1801
	5	Bosch	Germany	1775
oan: 14	6	Toyota	Japan	1652
	7	Qualcomm	USA	1305
	8	Siemens	Germany	1272
SA: 6	9	Philips	Netherlands	1230
	10	Ericsson	Sweden	1197
	11	LG Electronics	Korea	1094
rmany: 3	12	Mitsubishi Electric	Japan	1042
	13	NEC	Japan	999
	14	Fujifilm	Japan	891
nina : 2	15	Hitachi	Japan	745
	16	Samsung	Korea	683
	17	Fujitsu	Japan	671
rea: 2	18	Nokia	Finland	670
	19	BASF	Germany	644
	20	Intel	USA	640
etherlands : 1	21	HP	USA	620
	22	3M	USA	586
	23	Sony	Japan	578
nland: 1	24	Mitsubishi Heavy Indus	Japan	566
	25	Sumitomo	Japan	558
eden:1	26	Sanyo	Japan	537
	27	Microsoft	USA	531
	28	IBM	USA	528
nce: 0	29	Canon	Japan	480
	30	Murata Manufacturing	Japan	462
		i la ata manaractarting	Jupun	102
	38	CEA	France	391
	44	Alcatel Lucent	France	346

CEA in top-ranking position worldwide in KETs « hardware »

Ranking of European public R&D institutions on patent application









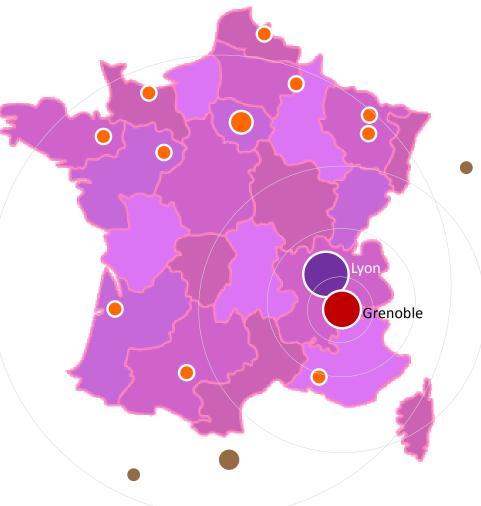
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15% of PhDs are outsourced

Proximity effect: 40% of PhDs in the labs located in the Rhône-Alpes area

450 PhDs (150 per year) 75 PhDs funded by CEATech in academic laboratories (25 annually) PhDs in academic labs funded by CEATech



leti ^{CE2tech}

LETI, TECHNOLOGY RESEARCH INSTITUTE



Founded in 1967, based in France (Grenoble) / offices in USA and Japan

Optics and Photonics Division





Created in 1978 300 researchers, engineers and PhD students



~55 M€ budget 90% from external revenue



500 patents in portfolio 91 new patents in 2017



NEW in 2017 : PHOTONICS BUILDING



Dedicated clean rooms for III-V and II-VI materials (growth, epitaxy, process and packaging) on versatile substrate geometries up to 150 mm

Electro-optical test and characterization facilities

Design and simulation capabilities (process, growth, optics ...)

Other facilities and research activities in Leti



CHARACTERIZATION



MEMS



HEALTHCARE

IC DESIGN

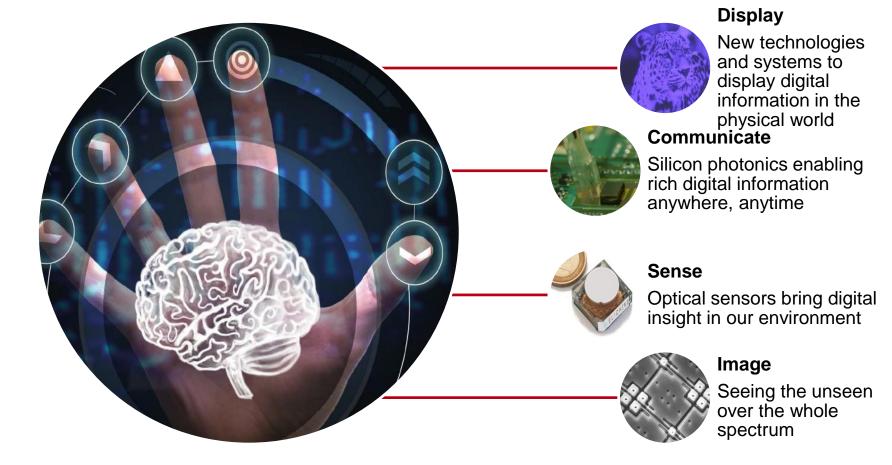


COMPLEX SYSTEMS





PHOTONICS, A KEY ENABLING TECHNOLOGY



OUR MAIN RESEARCH PROGRAMS

Displays

High brightness microdisplays Innovative solutions for augmented reality



Visible imaging

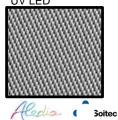
Innovative pixels (Global shutter, SPAD) Integrated filters (thin films, nanostructured) Integrated optics (refractive or diffractive)





Solid-state light emission

Integrated smart LEDs LEDs on Si UV LED



Cooled IR imaging

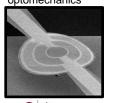
Increase resolution and size of image sensors (MCT, InSb) Increase operating T



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Optical sensors

Integrated optical gas and particle sensors Explore biophotonics and optomechanics



O mir sense eLichens

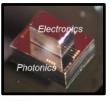
Bolometer imaging

Decrease sensor cost and size Develop THz cameras and applications

ULIS

Silicon photonics

Laser integration Integrate photonic circuits in electronic chips and boards





Technologies for imaging

Photonic materials and technologies (III-V, II-VI, Si) Small pitch hybridation Wafer level packaging

